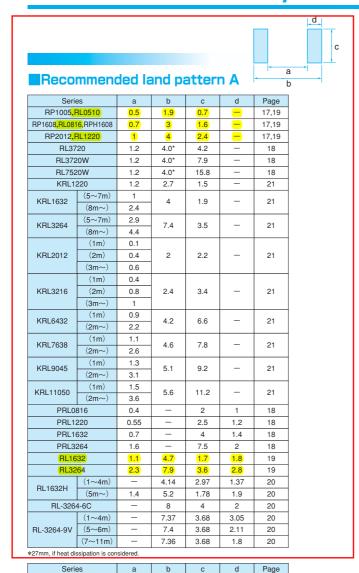
Design Supportive Data

Recommended land pattern (Dimention: mm)

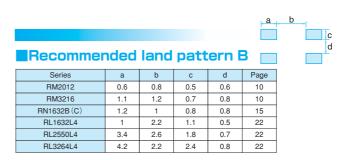


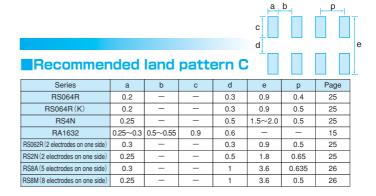
RN732X	1.2	_	1.2	0.6	13
RR1632	2.4	_	1.6	0.6	13
RR2632	2.4	_	2.6	0.6	13
PFR (GFR) 03	0.3	1	0.3~0.7	_	27
PFR (GFR) 05	0.5	1.5	0.4~0.8	_	27
EF2A51A	0.46	1.22	0.55	0.38	36
Series	а	b	С	d	Page
PCAA031 (B) T	1.1	3.5	1.3	_	24
PCAA041B	1.6	4.5	1.7	_	24
PCMC042T	2.2	5.2	2.5	_	24
PCMC053T	3	7	2.5	_	24
PCMC (B) 063T	3.7	7.4	3.5	_	23
PCMC (B) 104T	4.5	11.5	4	_	23
PCMC133E	8	14.5	5	_	23
PCMC135T	8	14.5	5	_	23
Chip Size	a	b	С	d	
06*03	0.28	0.76	0.34	_	
1.0*0.5	0.5	1.6	0.6	_	
1.6*0.8	1	3	1.2	_]
2.0*1.25	1.2	4	1.65	_]
3.2*1.6	2.2	5	2	_]
Series	Page		Series		Page
RG Series	8		RT Serie	es	16
RGH Series	12		TFL Seri	es	30

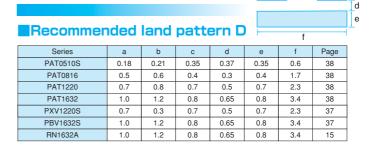
13

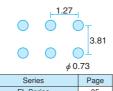
RR Series (except RR1632, RR2632)

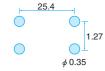
RRS Series











b

С

Series	Page	
FL Series	35	

Series	Page
CL1L5	40
CL2LA	40

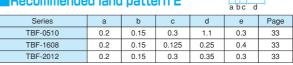
50 ohm IN

> GND Φ

GND

OUT 50 ohm

Recommended land pattern E





30

HPL Series

HTC Series